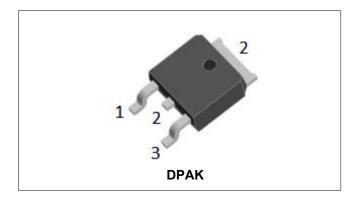


12CWQ10FN

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12CWQ10FN SCHOTTKY RECTIFIER

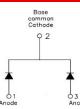


Small foo

Features

- Small foot print, surface mountable
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Green products in compliance with the ROHS directive
- "-A" is an AEC-Q101 qualified device
- Terminals finish: Tin Lead-free plated
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Applications

- Disk drives
- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery charging

Maximum Ratings(Tc =25°C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	-	100	V
Average Rectified Forward Current	IF (AV)	50% duty cycle $@T_c = 105^{\circ}C$, rectangular wave form	6(peg leg) 12(peg device)	A
Peak One Cycle Non-Repetitive Surge Current(peg leg)	I _{FSM}	8.3 ms, half Sine pulse	130	А

Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop	V _{F1}	@ 6A, Pulse, T _J = 25 °C	0.73	0.80	V
(per leg) *	V _{F2}	@ 6A, Pulse, T _J = 125 °C	0.60	0.65	V
Reverse Current (per leg) *	I _{R1}	$@V_R = rated V_R, T_J = 25 \circ C$	0.001	1.0	mA
	I _{R2}	@V _R = rated V _R , T _J = 125 °C	1	4.0	mA
Junction Capacitance (per leg)	Ст	@V _R = 5V, T _C = 25 °C f _{SIG} = 1MHz	200	250	pF

* Pulse width < 300 µs, duty cycle < 2%

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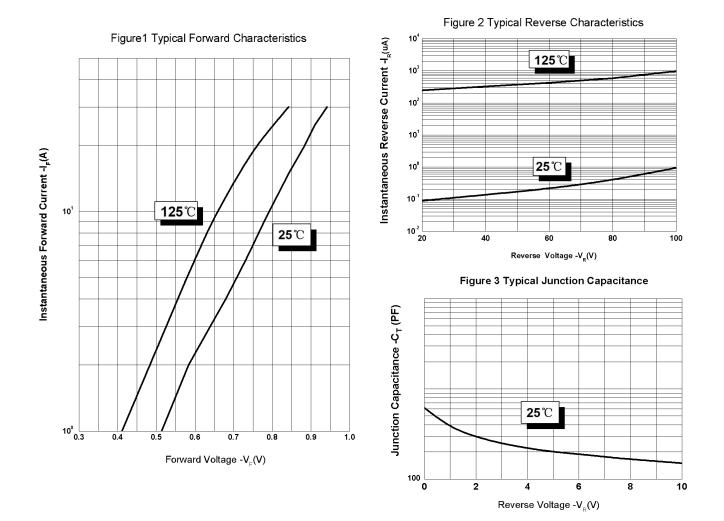
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Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units	
Junction Temperature	TJ	-	-55 to +150	°C	
Storage Temperature	T _{stg}	-	-55 to +150	°C	
Typical Thermal Resistance Junction to	R _{0JC}		3.0(per leg)	°C/W	
Case	RθJC	-	1.5(per device)	-0/00	
Approximate Weight	wt	-	0.39	g	
Case Style	DPAK				

Ratings and Characteristics Curves



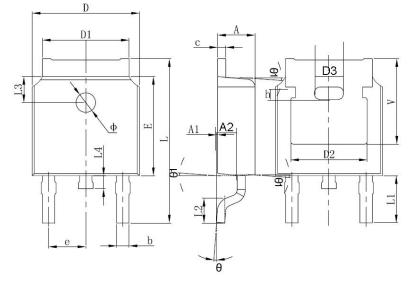


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RoHS 🗭

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Mechanical Dimensions DPAK



The outline from different package houses may have slight differences. So the outline above is just schematic. The dimensions are controlled per specifications.

Symbol	Dimensions in millimeters			
	Min.	Typical	Max.	
A	2.18	-	2.39	
A1	-	-	0.13	
b	0.64	-	0.89	
С	0.46	-	0.89	
D	6.35	-	6.73	
D1	4.95	-	5.46	
D2	4.32	-	-	
E	5.97	6.1	6.22	
е		2.29BSC		
L	9.4	-	10.41	
L1	2.90 REF.			
L2	1.4	1.52	1.78	
L3	1.60 REF.			
L4	-	-	1.02	
Φ	1.1	-	1.3	
Θ	0°	-	10°	
V	5.21	-	_	

12 CW

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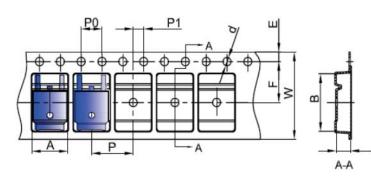
SSG

Ordering Information

Device	Package	Shipping
12CWQ10FN	DPAK (Pb-Free)	2500pcs / reel
12CWQ10FNTR	DPAK (Pb-Free)	2500pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Carrier Tape Specification DPAK



12CV	VQ10FN	
	XXXXX	
		긔
U.		

Marking Diagram

Where XXXXX is YYWWL

- = Forward Current (12A)
- = Configuration
- = Device Type
- = Reverse Voltage (100V) = Package type
- = Facka
- = Year
- = Week
- = Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

SYMBOL	Millimeters		
STWBOL	Min.	Max.	
A	6.80	7.00	
В	10.40	10.60	
С	2.60	2.80	
d	Φ1.45	Φ1.65	
E	1.65	1.85	
F	7.40	7.60	
P0	3.90	4.10	
Р	7.90	8.10	
P1	1.90	2.10	
W	15.90	16.30	

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